

Features

- Adjustable DC Characteristic
- Transmit and Receive Gain Adjustable
- Symmetrical Input of Microphone Amplifier
- Anti-clipping in Transmit Direction
- Automatic Line-loss Compensation
- Built-in Ear Protection
- DTMF and MUTE Input
- Adjustable Sidetone Suppression Independent of Sending and Receiving Amplification
- Integrated Amplifier for Open-listening Operation
- Anti-clipping for Loudspeaker Amplifier
- Improved Acoustical Feedback Suppression
- Selectable Line Impedance
- Voice Switch
- Supply Voltages for All Functional Blocks of a Subscriber Set
- Operation Possible from 10-mA Line Current
- Filters Against EMI on Critical I/O



Monolithic Integrated Feature Phone Circuit

U4089B-P

Benefits

- Complete System Integration of Analog Signal Processing on One Chip
- Very Few External Components
- Less Components for EMI protection

Applications

- Feature Phones
- Answering Machines
- Fax Machines
- Speaker Phones

1. Description

The telephone circuit U4089B-P is a linear integrated circuit for use in feature phones, answering machines and fax machines. It contains the speech circuit, sidetone equivalent and ear protection rectifiers. The circuit is line-powered and contains all components necessary for the amplification of signals and adaptation to the line.

An integrated voice switch with loudspeaker amplifier enables open-listening or hands-free operation. With an anti-feedback function, acoustical feedback during open listening can be reduced significantly. The generated supply voltage is suitable for a wide range of peripheral circuits.

Electrostatic sensitive device.
Observe precautions for handling.



Rev. 4518C-CORD-10/05



Figure 1-1. Simple Block Diagram

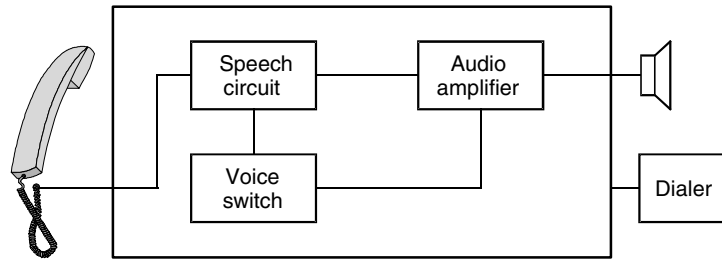
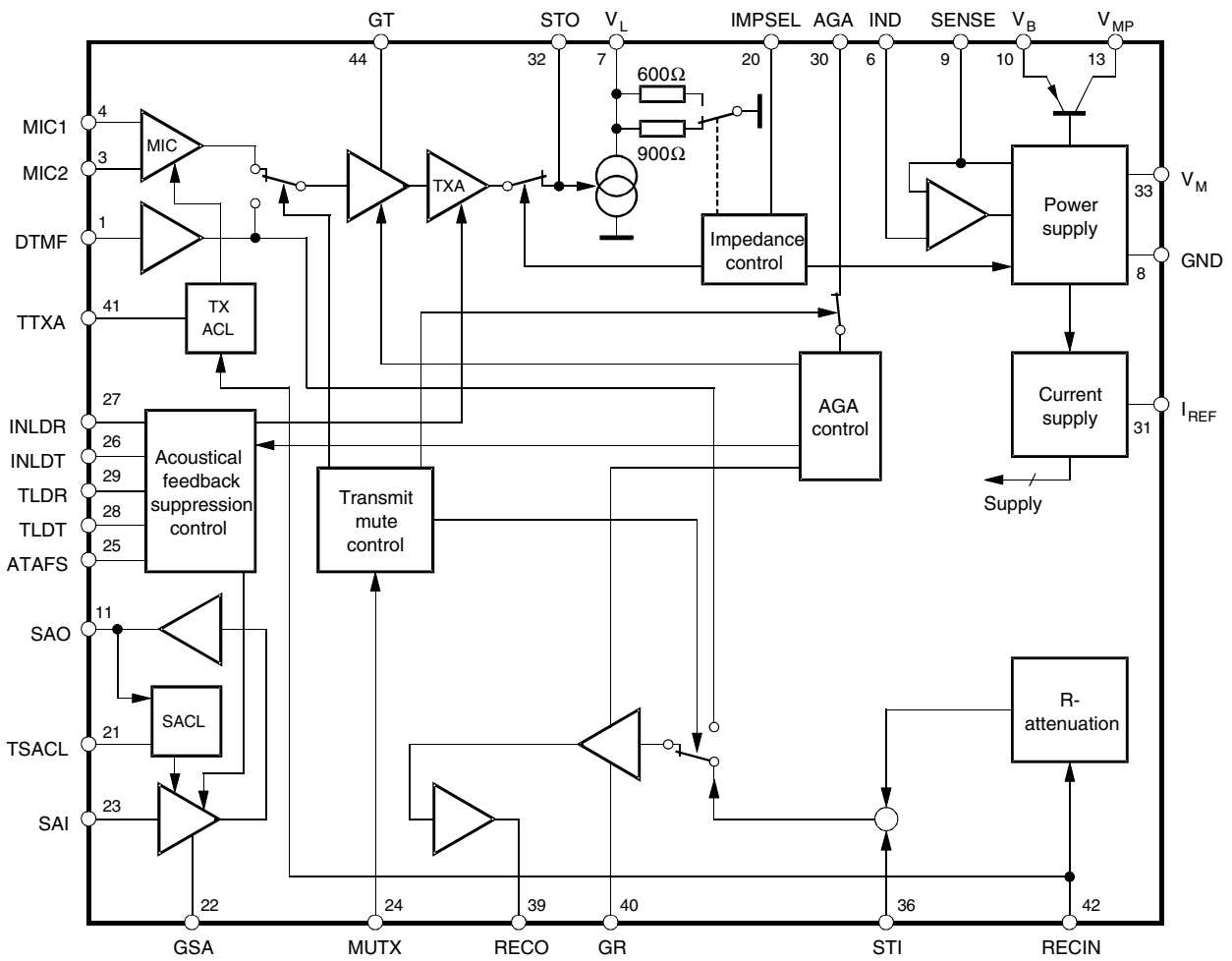


Figure 1-2. Block Diagram



2. Pin Configuration

Figure 2-1. Pinning SSO44

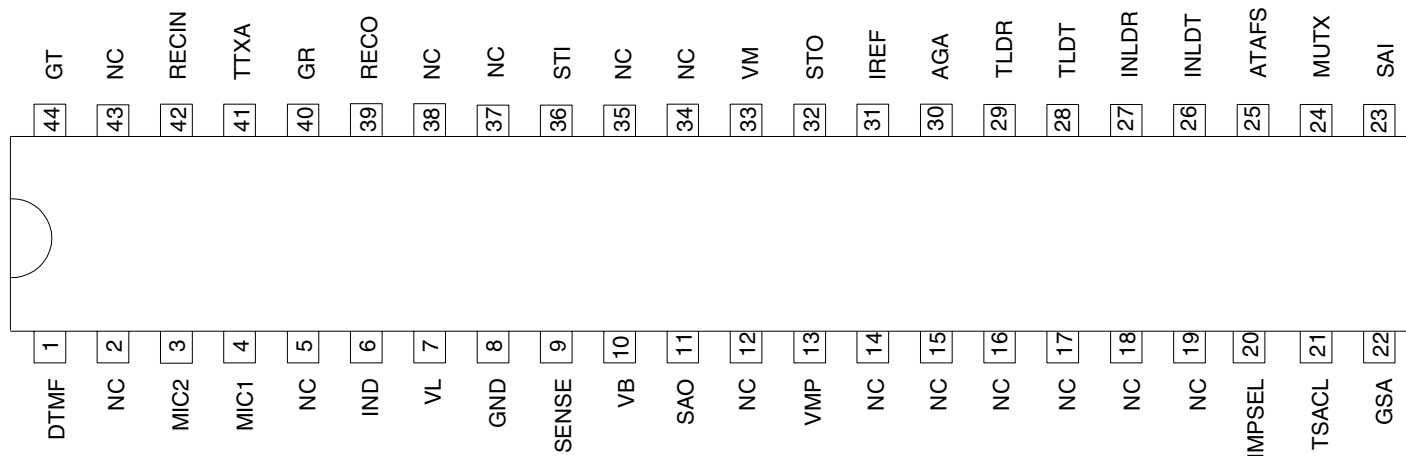


Table 2-1. Pin Description

Pin	Symbol	Function
1	DTMF	Input for DTMF signals. Also used for the answering machine and hands-free input.
3	MIC 2	Non-inverting input of microphone amplifier.
4	MIC 1	Inverting input of microphone amplifier.
6	IND	The internal equivalent inductance of the circuit is proportional to the value of the capacitor at this pin. A resistor connected to ground may be used to reduce the DC line voltage.
7	V _L	Line voltage.
8	GND	Reference point for DC and AC output signals.
9	SENSE	A small resistor (fixed) connected from this pin to V _L sets the slope of the DC characteristic, and affects the line-length equalization characteristics, and the line current at which the loudspeaker amplifier is switched on.
10	V _B	Unregulated supply voltage for peripheral circuits (voice switch); limited to typically 7V.
11	SAO	Output of loudspeaker amplifier.
13	V _{Mp}	Regulated supply voltage 3.3V for peripheral circuits. The maximum output current is 2 mA.
20	IMPSEL	Control input for selection of line impedance 1) 600Ω 2) 900Ω 3) Mute of second transmit stage (TXA); also used for indication of external supply (answering machine); last chosen impedance is stored.
21	TSACL	Time constant of anti-clipping of speaker amplifier.
22	GSA	Current input for setting the gain of the speaker amplifier. Adjustment characteristic is logarithmical. For RGSA > 2 MΩ, the speaker amplifier is switched off.
23	SAI	Speaker amplifier input (for loudspeaker, tone ringer and hands-free use).

Note: Filters against electromagnetic interference (EMI) are located at pins MIC1, MIC2, RECIN and STI.

Table 2-1. Pin Description (Continued)

Pin	Symbol	Function
24	MUTX	Three-state input of transmit mute: 1) Speech condition; inputs MIC1/MIC2 active. 2) DTMF condition; input DTMF active. A part of the input signal is passed to the receiving amplifier as a confidence signal during dialing. 3) Input DTMF used for answering machine and hands-free use; receive branch is not affected.
25	ATAFS	Attenuation of acoustical feedback suppression. Maximum attenuation of AFS circuit is set by a resistor at this pin. Without the resistor, AFS is switched off.
26	INLDT	Input of transmit level detector.
27	INLDR	Input of receive level detector.
28	TLDT	Time constant of transmit level detector.
29	TLDR	Time constant of receive level detector.
30	AGA	Automatic gain adjustment with line current. A resistor connected from this pin to GND sets the starting point. Maximum gain change is 6 dB.
31	IREF	Internal reference current generation; RREF = 62 k Ω ; IREF = 20 μ A
32	STO	Side-tone reduction output. Output resistance is approximately 300 Ω . Maximum load impedance is 10 k Ω .
33	V _M	Reference node for microphone-earphone and loudspeaker amplifier. Supply for electret microphone (IM \geq 300 mA).
36	STI	Input for side-tone network.
39	RECO	Output of receiving amplifier.
40	G _R	A resistor connected from this pin to GND sets the receiving amplification of the circuit; amplifier RA1 can be muted by applying V _{MP} to G _R .
41	TTXA	Time constant of anti-clipping in transmit path.
42	RECI	Input of receiving path; input impedance is typically 80 k Ω .
44	G _T	A resistor from this pin to GND sets the amplification of microphone and DTMF signals; the input amplifier can be muted by applying V _{MP} to G _T .

Note: Filters against electromagnetic interference (EMI) are located at pins MIC1, MIC2, RECI and STI.

3. DC Line Interface and Supply-voltage Generation

The DC line interface consists of an electronic inductance and an output stage which charges the capacitor at V_B . The value of the equivalent inductance is given by:

$$L = R_{SENSE} \times C_{IND} \times (R_{DC} \times R_{30}) / (R_{DC} + R_{30})$$

In order to improve the supply during worst-case operating conditions, the PNP current source (I_{BOPT}) supplies an extra amount of current to the supply voltages when the NPN in parallel is unable to conduct current.

The U4089B-P contains a series regulator which provides a supply voltage V_{MP} of 3.3V at 2 mA suitable for a microprocessor.

Figure 3-1. DC Line Interface With Electronic Inductance and Generation of Regulated and Unregulated Supply

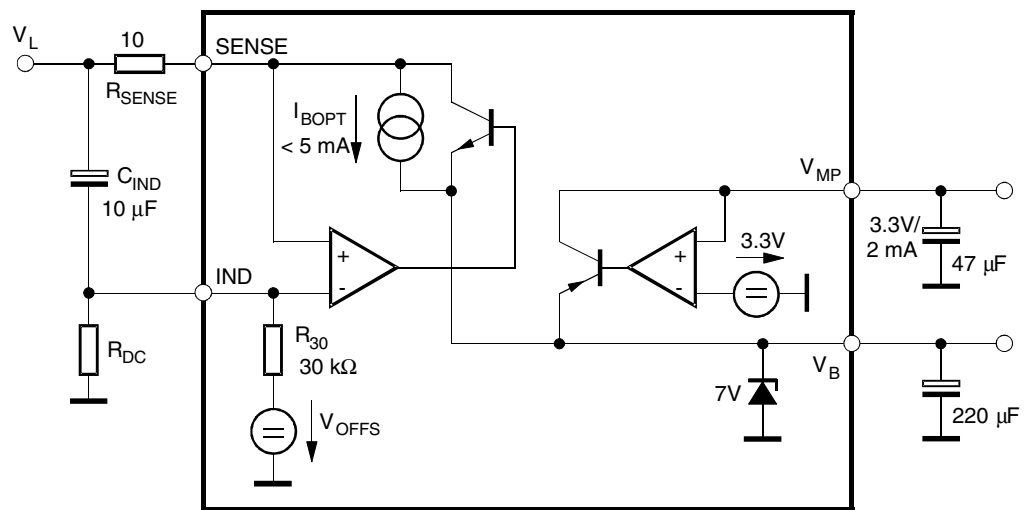
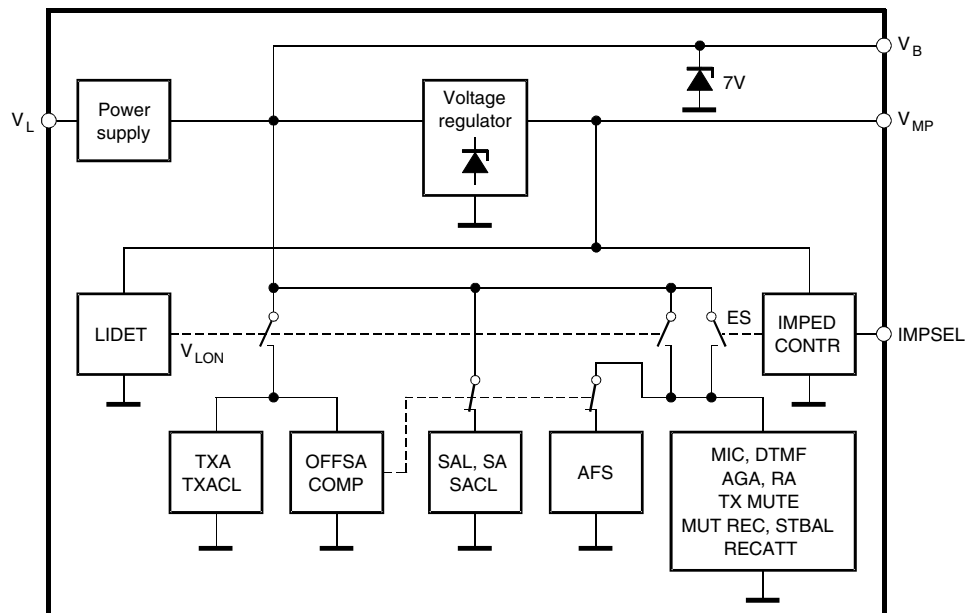


Figure 3-2. Functional Blocks for Power Supply



1. In speech condition, the system is supplied by the line current. If the LIDET block detects a line voltage above the fixed threshold (1.9V), the internal signal VLON is activated, thus switching on all blocks of the chip.

For line voltages below 1.9V, the switches remain in their quiescent state as shown in [Figure 3-2](#).

OFFSACOMP disables the group listening feature (SAI, SA, SACL, AFS) below line currents of approximately 10 mA.

2. Selecting IMPSEL = high impedance activates all switches on the ES line.

4. Acoustic Feedback Suppression

Acoustical feedback from the loudspeaker to the handset microphone may cause instability in the system. The U4089B-P offers a very efficient feedback suppression circuit which uses a modified voice switch topology. [Figure 4-1](#) shows the basic system configuration.

Two attenuators (TX ATT and RX ATT) reduce the critical loop gain by introducing an externally adjustable amount of loss either in the transmit or in the receive path. The sliding control in block ATT CONTR determines whether the TX or the RX signal has to be attenuated. The overall loop gain remains constant under all operating conditions.

Selection of the active channel is made by comparison of the logarithmically compressed TX and RX envelope curves.

The system configuration for group listening, which is realized in the U4089B-P, is illustrated in [Figure 4-2](#). TXA and SAI represent the two attenuators; the logarithmic envelope detectors are shown in a simplified way (operational amplifiers with two diodes).

Figure 4-1. Basic Voice-switch System

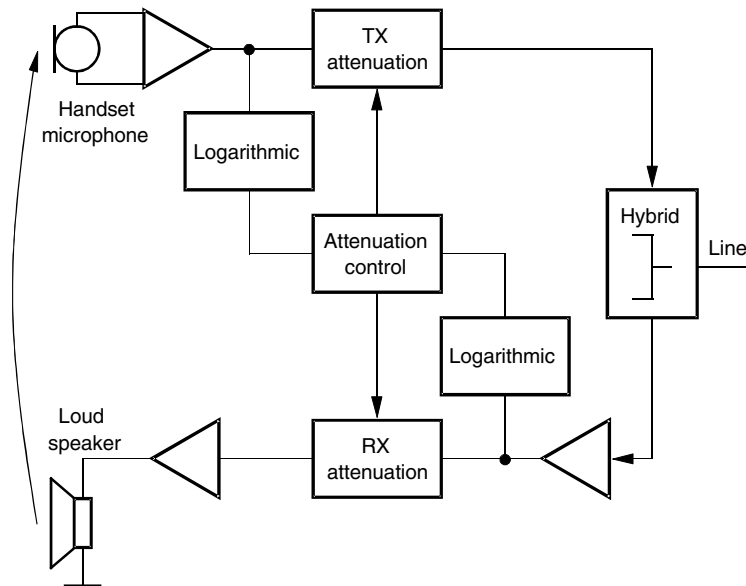


Figure 4-2. Integration of the Acoustic Feedback-suppression Circuit Into the Speech Circuit Environment

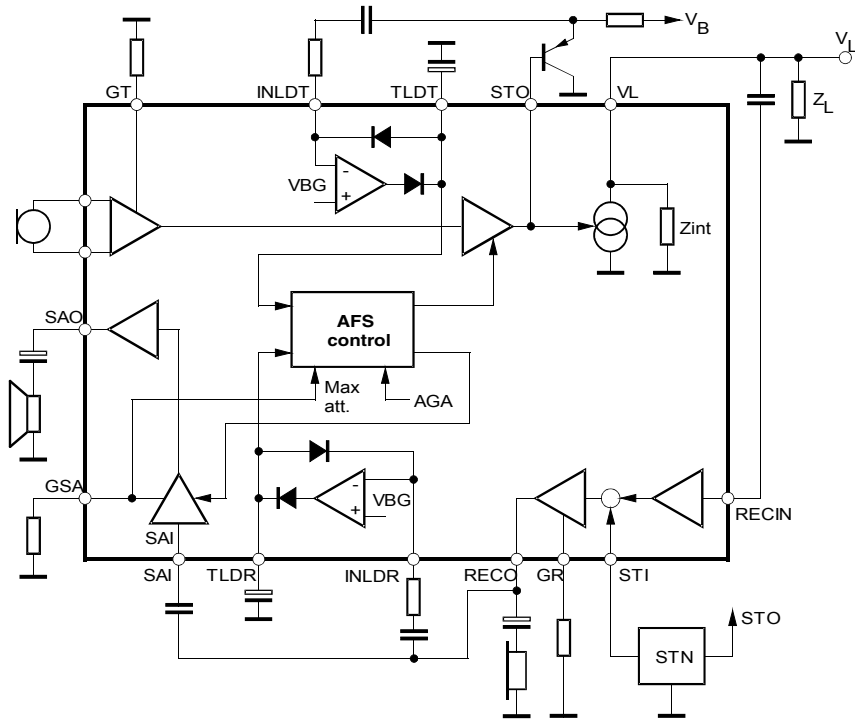


Figure 4-3. Acoustic Feedback Suppression by Alternative Control of Transmit and Speaker Amplifier Gain

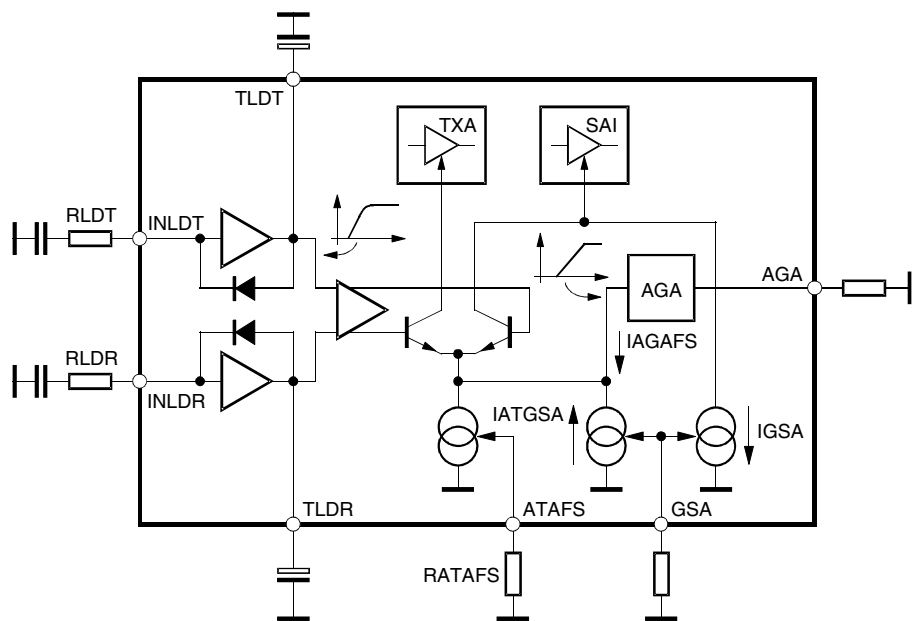


Figure 4-3 on page 7 provides a detailed diagram of the AFS (Acoustic Feedback Suppression). Receive and transmit signals are first processed by logarithmic rectifiers in order to produce the speech envelopes at TLDT and RLDT. After amplification, a decision is made by the differential pair which direction should be transmitted.

The attenuation of the controlled amplifiers TXA and SAI is determined by the emitter current I_{AT} which is comprised of three parts:

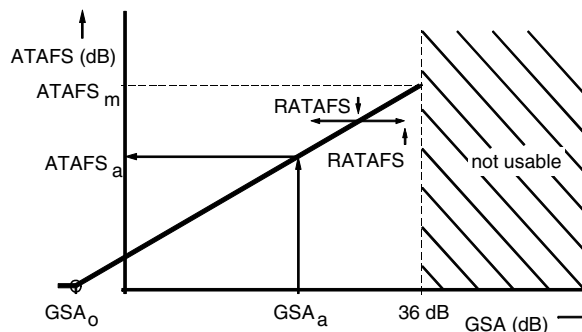
- I_{ATAFS} sets maximum attenuation
- I_{ATGSA} decreases the attenuation when speaker amplifier gain is reduced
- I_{AGAFS} decreases the attenuation according to the loop-gain reduction caused by the AGA function

$$I_{AT} = I_{ATAFS} - I_{ATGSA} - I_{AGAFS}$$

$$\Delta G = I_{AT} \times 0.67 \text{ dB}/\mu\text{A}$$

Figure 4-4 illustrates the principal relationship between speaker amplifier gain (GSA) and attenuation of AFS (ATAFS). Both parameters can be adjusted independently, but the internal coupling between them has to be considered. The maximum GSA value to be used is 36 dB. The shape of the characteristic is moved in the x-direction by adjusting resistor R_{ATAFS} , thus changing $ATAFS_m$. The actual value of the attenuation ($ATAFS_a$), however, can be determined by reading the value which belongs to the actual gain GSA_a . If the speaker amplifier gain is reduced, the attenuation of AFS is automatically reduced by the same amount in order to achieve a constant loop gain. Zero attenuation is set for speaker gains $GSA \geq GSA_0 = 36 \text{ dB} - ATAFS_m$.

Figure 4-4. Reducing Speaker Amplifier Gain Results in an Equal Reduction of AFS Attenuation



5. Operating Range of Speaker Amplifier

The basic behavior is illustrated in Figure 5-1. Actual values of $I_{L_{ON}}/I_{L_{OFF}}$ vary slightly with the adjustment of the DC characteristics and the selection of the internal line impedance.

Figure 5-1. Threshold of Speaker Amplifier

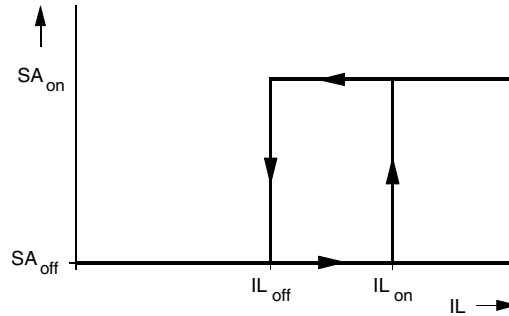
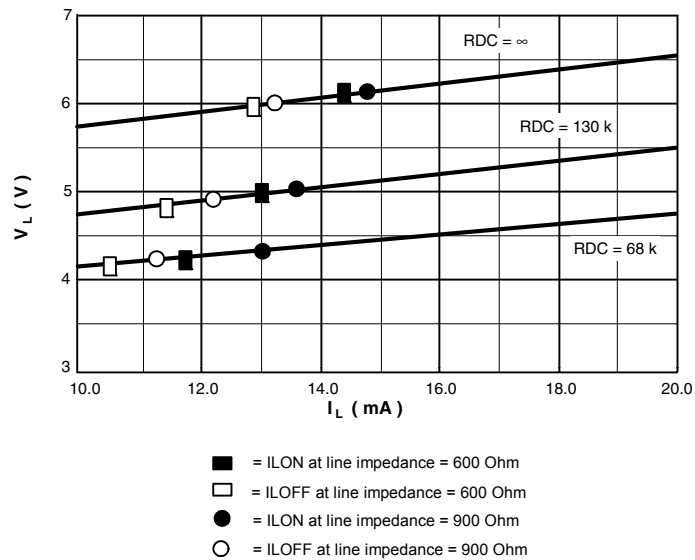


Figure 5-2. Comparator Thresholds Depend on DC Mask and Line Impedance



6. Absolute Maximum Ratings

Parameters	Symbol	Value	Unit
Line current	I_L	140	mA
DC line voltage	V_L	12	V
Junction temperature	T_j	125	°C
Ambient temperature	T_{amb}	-25 to +75	°C
Storage temperature	T_{stg}	-55 to +150	°C
Total power dissipation, $T_{amb} = 60^\circ\text{C}$, SSO44	P_{tot}	0.9	W
ESD (Human Body Model), ESD S 5.1 Standard	V_{ESD}	1.5	kV
ESD (Machine Model), JEDEC A115A	V_{ESD}	150	V

7. Thermal Resistance

Parameters	Symbol	Value	Unit
Junction ambient	R_{thJA}	70	K/W

8. Electrical Characteristics

$f = 1\text{ kHz}$, $0\text{ dBm} = 775\text{ mV}_{rms}$, $I_M = 0.3\text{ mA}$, $I_{MP} = 2\text{ mA}$, $RDC = 130\text{ k}\Omega$, $T_{amb} = 25^\circ\text{C}$, $RGSA = 560\text{ k}\Omega$, $Z_{ear} = 68\text{ nF} + 100\Omega$, $Z_M = 68\text{ nF}$, Pin 30 open (AGA), $V_{MUTX} = \text{GND}$, see [Figure 8-11 on page 22](#) (AC tests), unless otherwise specified.

Parameters	Test Conditions	Pin	Symbol	Min.	Typ.	Max.	Unit	
DC Characteristics (see Figure 8-8 on page 19)								
DC voltage drop over circuit	$I_L = 2\text{ mA}$		V_L	4.6	2.4	5.4	V	
	$I_L = 14\text{ mA}$						5.0	V
	$I_L = 60\text{ mA}$						7.5	V
	$I_L = 100\text{ mA}$						8.8	9.4
Transmission Amplifier, $I_L = 14\text{ mA}$, $V_{MIC} = 2\text{ mV}$, $RGT = 27\text{ k}\Omega$, unless otherwise specified								
Adjustment range of transmit gain			G_T	40	45	50	dB	
Transmitting amplification	$RGT = 12\text{ k}\Omega$ $RGT = 27\text{ k}\Omega$		G_T	47 39.8	48	49 41.8	dB	
Frequency response	$I_L \geq 14\text{ mA}$, $f = 300\text{ Hz to } 3400\text{ Hz}$		ΔG_T			± 0.5	dB	
Gain change with current	Pin 30 open (AGA), $I_L = 14\text{ mA to } 100\text{ mA}$		ΔG_T			± 0.5	dB	
Gain deviation	$T_{amb} = -10^\circ\text{C to } +60^\circ\text{C}$		ΔG_T			± 0.5	dB	
CMRR of microphone amplifier			CMRR	60	80		dB	
Input resistance of MIC amplifier	$RGT = 12\text{ k}\Omega$ $RGT = 27\text{ k}\Omega$		R_i	45	50 75	110	$\text{k}\Omega$	
Distortion at line	$I_L > 14\text{ mA}$ $V_L = 700\text{ mV}_{rms}$		d_t			2	%	
Maximum output voltage	$I_L > 19\text{ mA}$, $d < 5\%$ $V_{mic} = 25\text{ mV}$ $CTXA = 1\text{ }\mu\text{F}$		V_{Lmax}	1.8	3	4.2	dBm	

8. Electrical Characteristics (Continued)

f = 1 kHz, 0 dBm = 775 mV_{rms}, I_M = 0.3 mA, I_{MP} = 2 mA, RDC = 130 kΩ, T_{amb} = 25° C, RGSA = 560 kΩ, Z_{ear} = 68 nF + 100Ω, Z_M = 68 nF, Pin 30 open (AGA), V_{MUTX} = GND, see Figure 8-11 on page 22 (AC tests), unless otherwise specified.

Parameters	Test Conditions	Pin	Symbol	Min.	Typ.	Max.	Unit
Noise at line psophometrically weighted	I _L > 14 mA G _T = 48 dB		n _o		-80	-72	dBmp
Anti-clipping attack time release time	CTXA = 1 μF each 3 dB overdrive				0.5 9		ms ms
Gain at low operating current	I _L = 10 mA I _{MP} = 1 mA RDC = 68 kΩ V _{mic} = 1 mV I _M = 300 μA		G _T	40		42.5	dB
Distortion at low operating current	I _L = 10 mA I _M = 300 μA I _{MP} = 1 mA RDC = 68 kΩ V _{mic} = 10 mV		d _t			5	%
Line-loss compensation	I _L = 100 mA, RAGA = 20 kΩ		ΔG _{TI}	-6.4	-5.8	-5.2	dB
Mute suppression a) MIC muted (microphone preamplifier)	I _L ≥ 14 mA Mutx = open		G _{TM}	60	80		dB
Receiving Amplifier, I_L = 14 mA, RGR = 62 kΩ, unless otherwise specified, V_{GEN} = 300 mV							
Adjustment range of receiving gain	I _L ≥ 14 mA, single ended		G _R	-8		+2	dB
Receiving amplification	RGR = 62 kΩ RGR = 22 kΩ		G _R	-7.75	-7 1.5	-6.25	dB
Amplification of DTMF signal from DTMF IN to RECO	I _L ≥ 14 mA V _{MUTX} = V _{MP}		G _{RM}	1	4	7	dB
Frequency response	I _L > 14 mA, f = 300Hz to 3400Hz		ΔG _{RF}			±0.5	dB
Gain change with current	I _L = 14 mA to 100 mA		ΔG _R			±0.5	dB
Gain deviation	T _{amb} = -10° C to +60° C		ΔG _R			±0.5	dB
Ear protection	I _L ≥ 14 mA V _{GEN} = 11V _{rms}		EP			1.1	V _{rms}
MUTE suppression DTMF operation	I _L ≥ 14 mA V _{MUTX} = V _{MP}		ΔG _R	60			dB
Output voltage d ≤ 2%	I _L = 14 mA Z _{ear} = 68 nF			0.5			V _{rms}
Maximum output current d ≤ 2%	Z _{ear} = 100Ω			4			mA (peak)
Receiving noise psophometrically weighted	Z _{ear} = 68 nF + 100Ω I _L ≥ 14 mA		n _i		-80	-77	dBmp
Output resistance	Output against GND		R _o			10	Ω
Line-loss compensation	RAGA = 20 kΩ, I _L = 100 mA		ΔG _{RI}	-7.0	-6.0	-5.0	dB
AC impedance			Z _{imp}	840	900	960	Ω

8. Electrical Characteristics (Continued)

$f = 1 \text{ kHz}$, $0 \text{ dBm} = 775 \text{ mV}_{\text{rms}}$, $I_M = 0.3 \text{ mA}$, $I_{MP} = 2 \text{ mA}$, $RDC = 130 \text{ k}\Omega$, $T_{\text{amb}} = 25^\circ \text{C}$, $RGSA = 560 \text{ k}\Omega$, $Z_{\text{ear}} = 68 \text{ nF} + 100\Omega$, $Z_M = 68 \text{ nF}$, Pin 30 open (AGA), $V_{\text{MUX}} = \text{GND}$, see [Figure 8-11 on page 22](#) (AC tests), unless otherwise specified.

Parameters	Test Conditions	Pin	Symbol	Min.	Typ.	Max.	Unit
Gain at low operating current	$I_L = 10 \text{ mA}$ $I_{MP} = 1 \text{ mA}$ $I_M = 300 \mu\text{A}$ $V_{\text{GEN}} = 560 \text{ mV}$ $RDC = 68 \text{ k}\Omega$		G_R	-8	-7	-6	dB
Distortion at low operating current	$I_L = 10 \text{ mA}$ $I_{MP} = 1 \text{ mA}$ $V_{\text{GEN}} = 560 \text{ mV}$ $RDC = 68 \text{ k}\Omega$		d_R			5	%
Speaker Amplifier							
Minimum line current for operation	No AC signal		$I_{L\text{min}}$			15	mA
Input resistance		23		14		22	k Ω
Gain from SAI to SAO	$V_{\text{SAI}} = 3 \text{ mV}$, $I_L = 15 \text{ mA}$, $RGSA = 560 \text{ k}\Omega$ $RGSA = 20 \text{ k}\Omega$		G_{SA}	35.5	36.5 -3	37.5	dB dB
Output power	Load resistance $R_L = 50 \Omega$ $d < 5\%$ $V_{\text{SAI}} = 20 \text{ mV}$ $I_L = 15 \text{ mA}$ $I_L = 20 \text{ mA}$		P_{SA} P_{SA}	3	7 20		mW mW
Output noise (input SAI open) psophometrically weighted	$I_L > 15 \text{ mA}$		n_{SA}			200	$\mu\text{V}_{\text{psoph}}$
Gain deviation	$I_L = 15 \text{ mA}$ $T_{\text{amb}} = -10^\circ \text{C to } +60^\circ \text{C}$		ΔG_{SA}			± 1	dB
Mute suppression	$I_L = 15 \text{ mA}$, $V_L = 0 \text{ dBm}$, $V_{\text{SAI}} = 4 \text{ mV}$ Pin 23 open		V_{SAO}			-60	dBm
Gain change with current	$I_L = 15 \text{ mA to } 100 \text{ mA}$		ΔG_{SA}			± 1	dB
Resistor for turning off speaker amplifier	$I_L = 15 \text{ mA to } 100 \text{ mA}$		RG_{SA}	0.8	1.3	2	M Ω
Gain change with frequency	$I_L = 15 \text{ mA}$ $f = 300\text{Hz to } 3400\text{Hz}$		ΔG_{SA}			± 0.5	dB
Attack time of anti-clipping	20 dB overdrive		t_r		5		ms
Release time of anti-clipping			t_f		80		ms
TMF Amplifier Test Conditions: $I_{MP} = 2 \text{ mA}$, $I_M = 0.3 \text{ mA}$, $V_{\text{MUX}} = \text{VMP}$							
Adjustment range of DTMF gain	$I_L = 15 \text{ mA}$ Mute active		G_D	40		50	dB
DTMF amplification	$I_L = 15 \text{ mA}$, $V_{\text{DTMF}} = 8 \text{ mV}$ Mute active: $\text{MUX} = \text{VMP}$		G_D	40.7	41.7	42.7	dB
Gain deviation	$I_L = 15 \text{ mA}$ $T_{\text{amb}} = -10^\circ \text{C to } +60^\circ \text{C}$		G_D			± 0.5	dB

8. Electrical Characteristics (Continued)

f = 1 kHz, 0 dBm = 775 mV_{rms}, I_M = 0.3 mA, I_{MP} = 2 mA, RDC = 130 kΩ, T_{amb} = 25° C, RGSA = 560 kΩ, Z_{ear} = 68 nF + 100Ω, Z_M = 68 nF, Pin 30 open (AGA), V_{MUTX} = GND, see [Figure 8-11 on page 22](#) (AC tests), unless otherwise specified.

Parameters	Test Conditions	Pin	Symbol	Min.	Typ.	Max.	Unit
Input resistance	RGT = 27 kΩ RGT = 15 kΩ		R _i	60 26	180 70	300 130	kΩ
Distortion of DTMF signal	I _L ≥ 15 mA V _L = 0 dBm		d _D			2	%
Gain deviation with current	I _L = 15 mA to 100 mA		ΔGD			±0.5	dB
AFS Acousting Feedback Suppression							
Range of attenuation	I _L ≥ 15 mA			0		50	dB
Attenuation of transmit gain	I _L ≥ 15 mA, I _{INLDT} = 0 μA R _{ATAFS} = 30 kΩ I _{INLDR} = 10 μA		ΔG _T		45		dB
Attenuation of speaker amplifier	I _L ≥ 15 mA I _{INLDP} = 0 μA R _{ATAFS} = 30 kΩ I _{INLDR} = 10 μA		ΔG _{SA}		50		dB
AFS disable	I _L ≥ 15 mA		V _{ATAFS}	1.5			V
Supply Voltages, V_{mic} = 25 mV, T_{amb} = -10° C to +60° C							
V _{MP}	I _L = 14 mA, RDC = 68 kΩ I _{MP} = 2 mA		V _{MP}	3.1	3.3	3.5	V
V _M	I _L ≥ 14 mA, I _M = 300 μA RDC = 130 kΩ		V _M	1.4		3.3	V
V _B	I _B = +20 mA, I _L = 0 mA		V _B		7	7.6	V
MUTX Input (see Figure 8-9 on page 20)							
Input current	V _{MUTX} = V _{MP} V _{MUTX} = GND		I _{MUTX} I _{MUTX}		+20 -20	+30 -30	μA μA
Input voltage	Input high		V _{MUTX}	V _{MP} - 0.3V			V
	Input low		V _{MUTX}			0.3	V

Table 8-1. U4089B-P Control

MUTX		MODE
0	MIC1, MIC2 transmit enabled receive enable AFS = on AGA = on TXACL = on	Speech
Z	DTMF transmit enabled receive enable AFS = on AGA = on TXACL = on	For answering machine
1	DTMF transmit enabled DTMF to receive enable AFS = off AGA = off TXACL = off	DTMF dialling

IMPSEL		MODE
0	Line impedance = 600Ω TXA = on ES = off	Speech
0 to Z	Line impedance = 600Ω TXA = off ES = on	Transmit mute
1 to Z	Line impedance = 900Ω TXA = off ES = on	Transmit mute
1	Line impedance = 900Ω TXA = on ES = off	Speech

Logic level
0 = < (0.3V)
Z = > (1V) < ($V_{MP} - 1V$) or (open input)
1 = > ($V_{MP} - 0.3V$)

AFS = Acoustical feedback-suppression control
 AGA = Automatic gain adjustment
 TXACL = Transmit anti-clipping control
 ES = External supply

Figure 8-1. Typical DC Characteristic

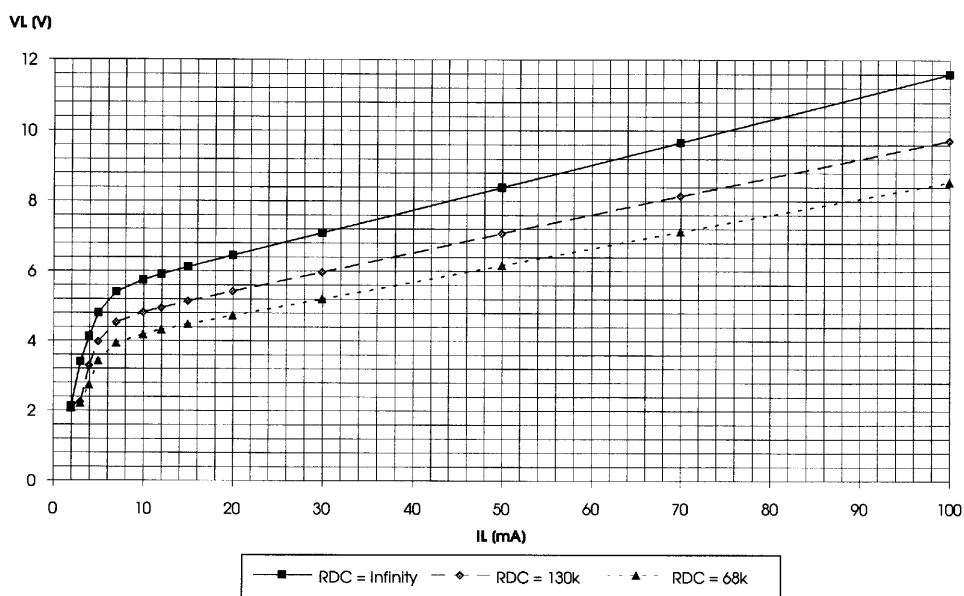


Figure 8-2. Typical Adjustment Range of the Transmit Gain

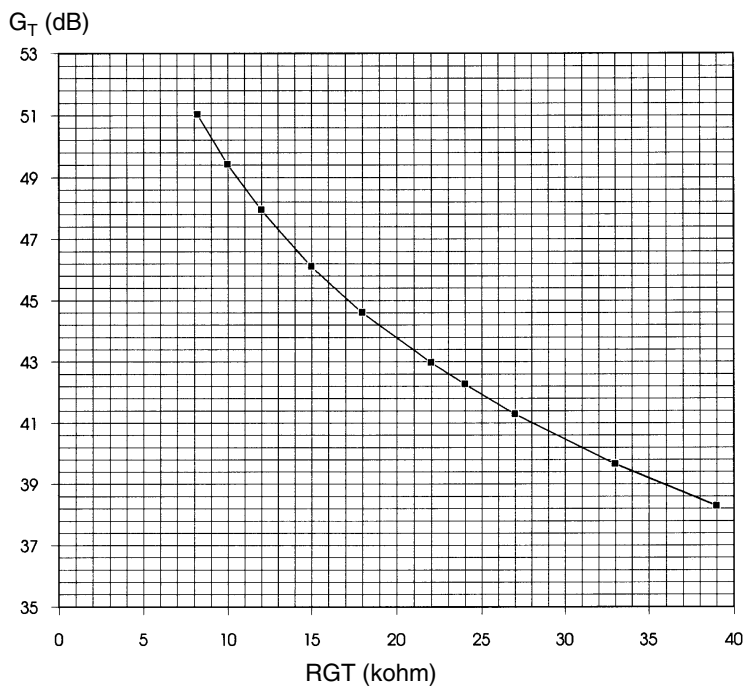


Figure 8-3. Typical Adjustment Range of the Receive Gain

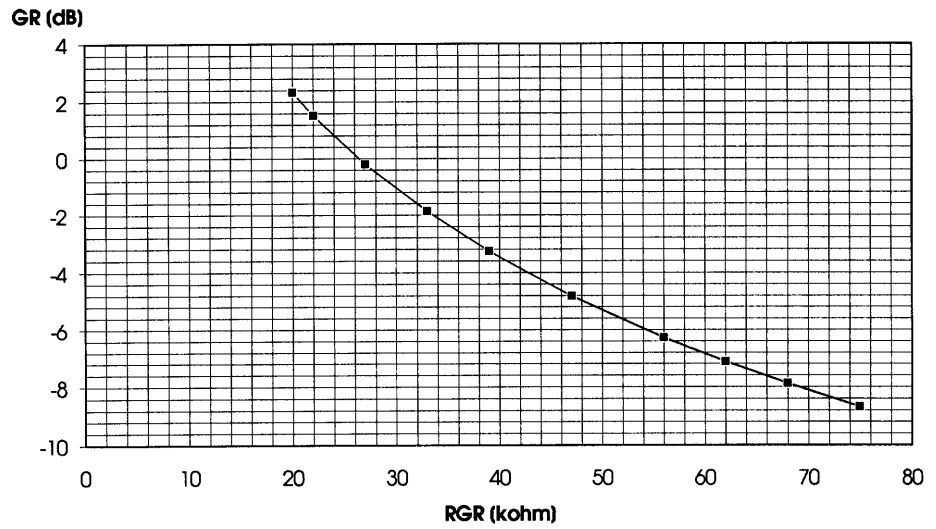


Figure 8-4. Typical AGA Characteristic

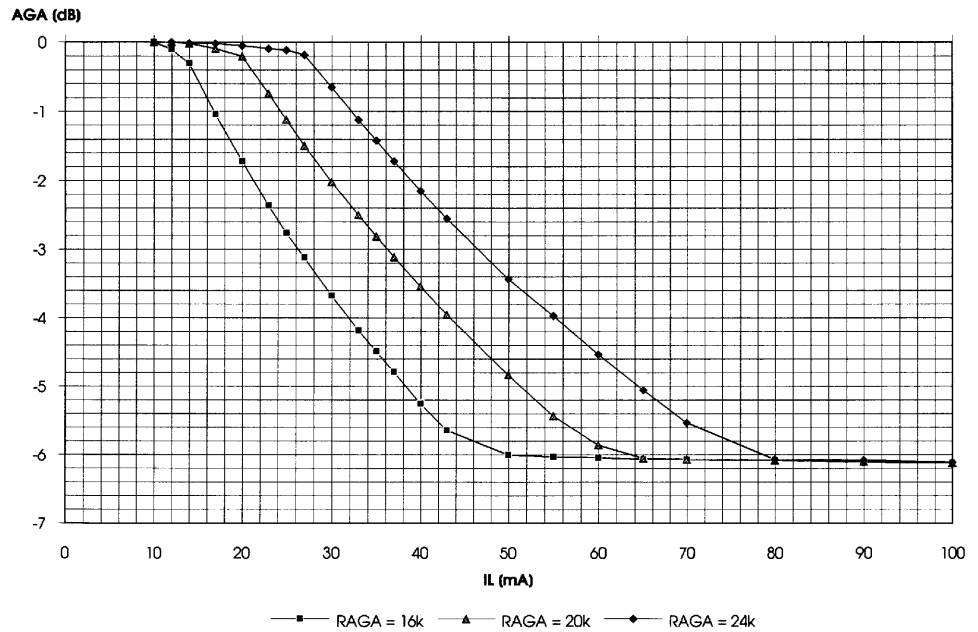


Figure 8-5. Typical Load Characteristic of V_B for a Maximum (RDC = infinity) DC Characteristic and a 3-mW Loudspeaker Output

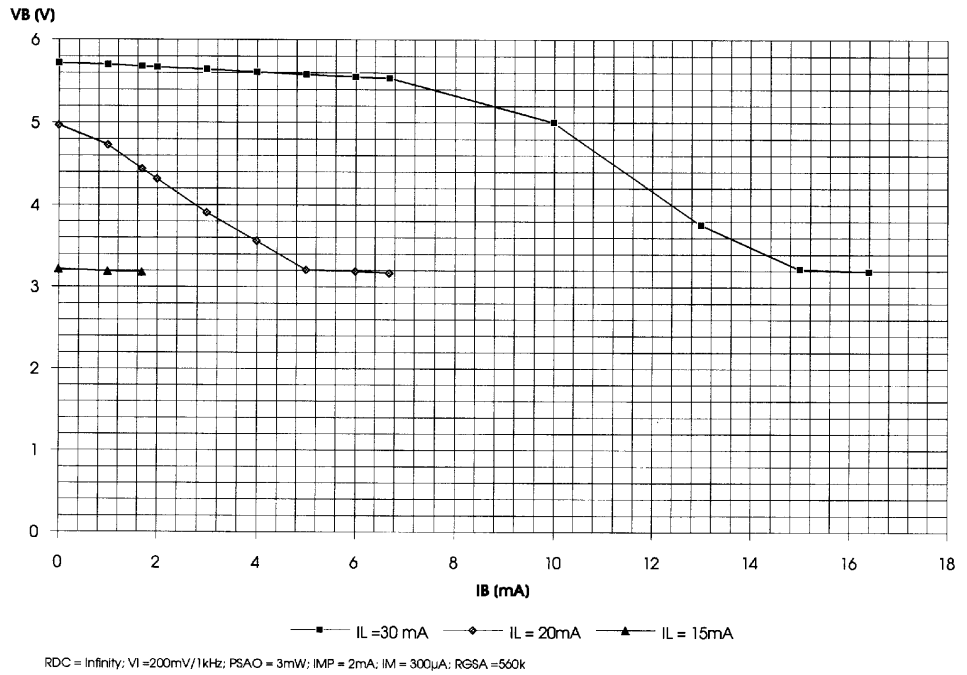


Figure 8-6. Typical Load Characteristic of V_B for a Medium DC Characteristic (RDC = 130 k Ω) and a 3-mW Loudspeaker Output

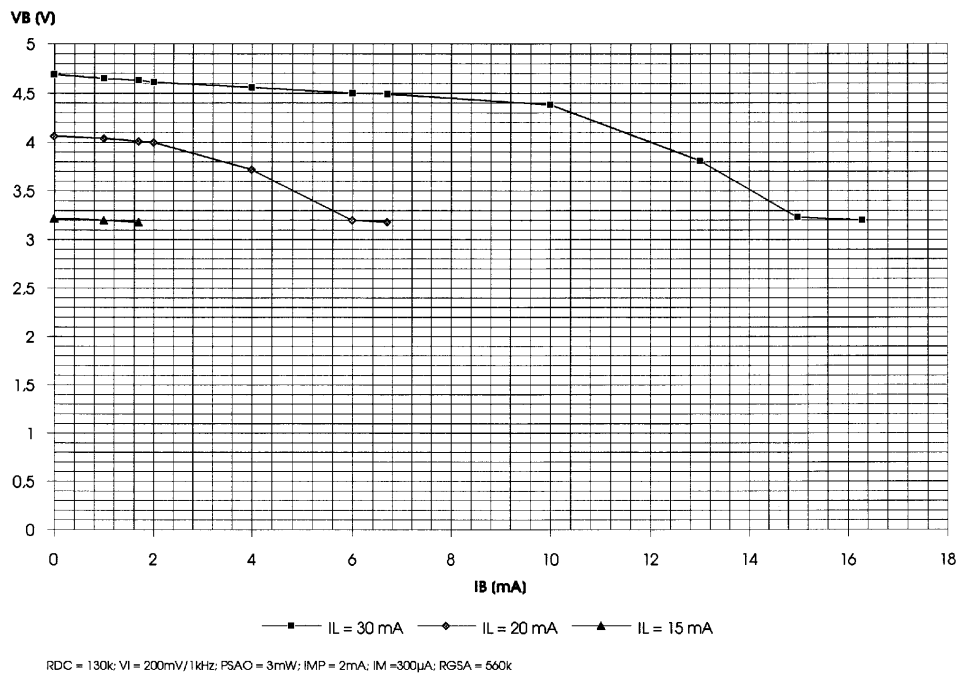


Figure 8-7. Typical Load Characteristic of V_B for a Minimum DC Characteristic (RDC = 68 k Ω) and a 3-mW Loudspeaker Output

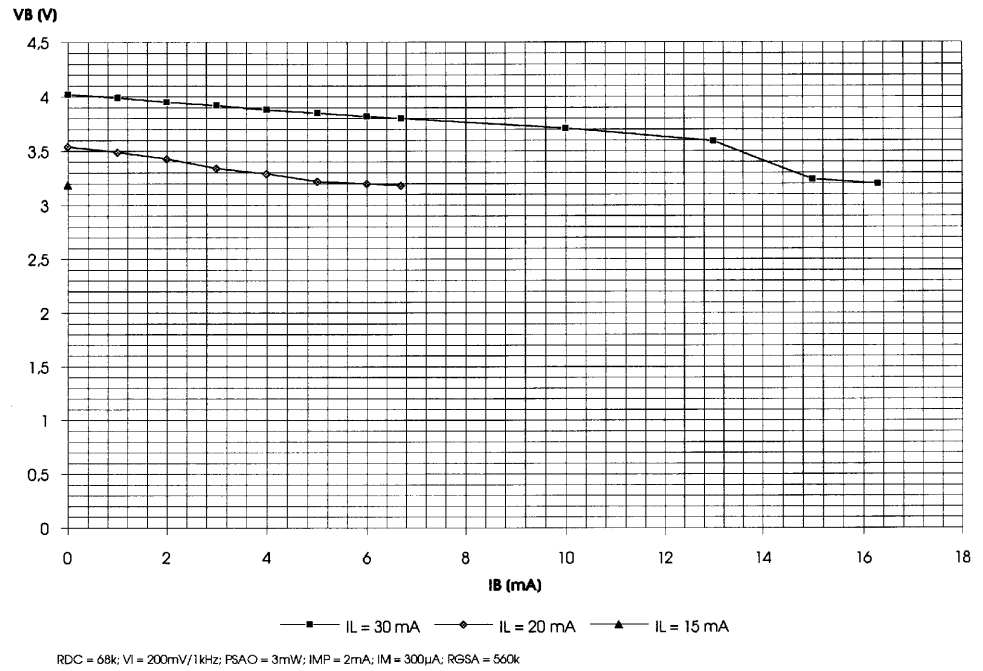


Figure 8-8. DC Voltage Absolute

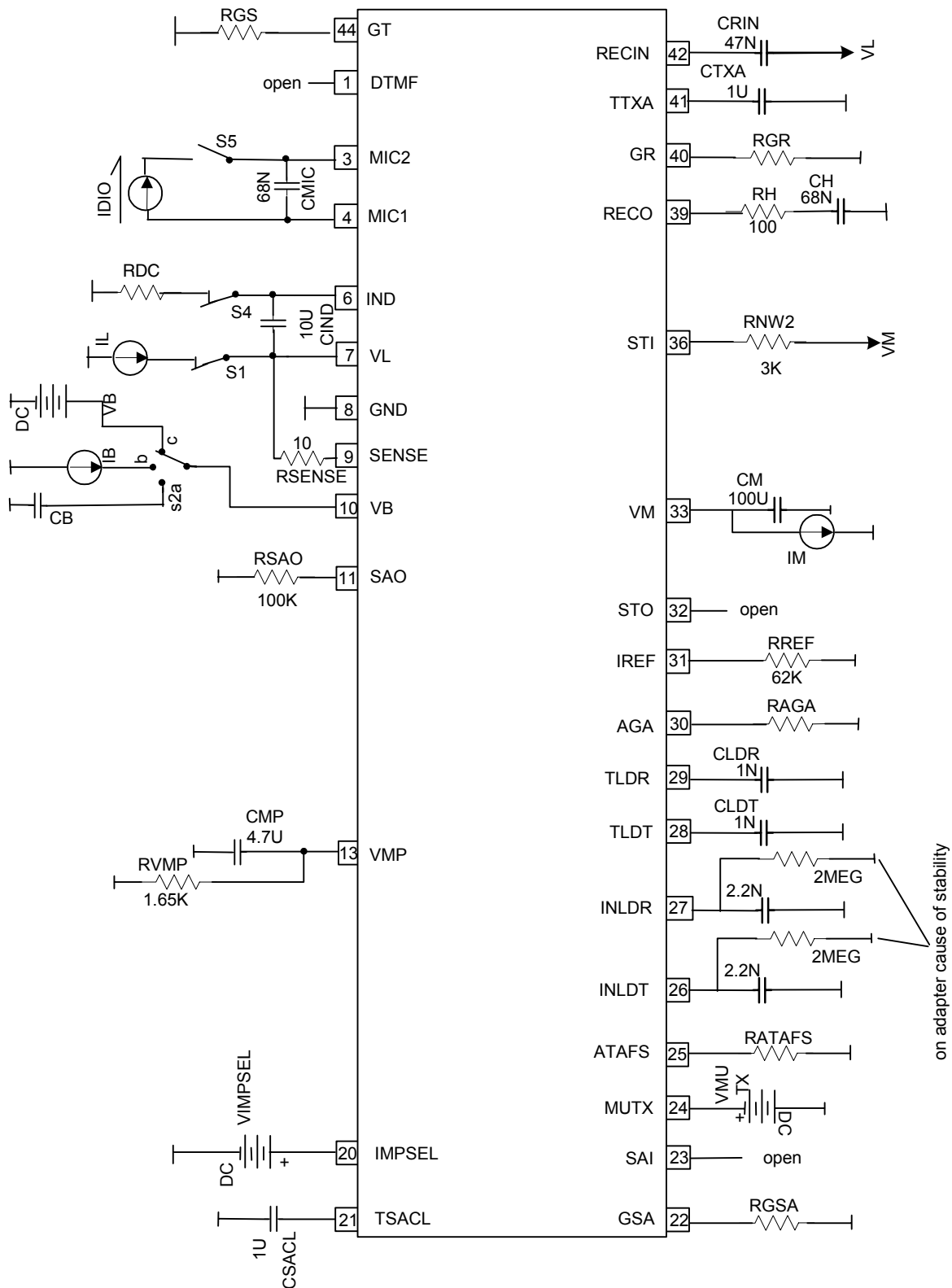


Figure 8-9. DC Voltage Current Test

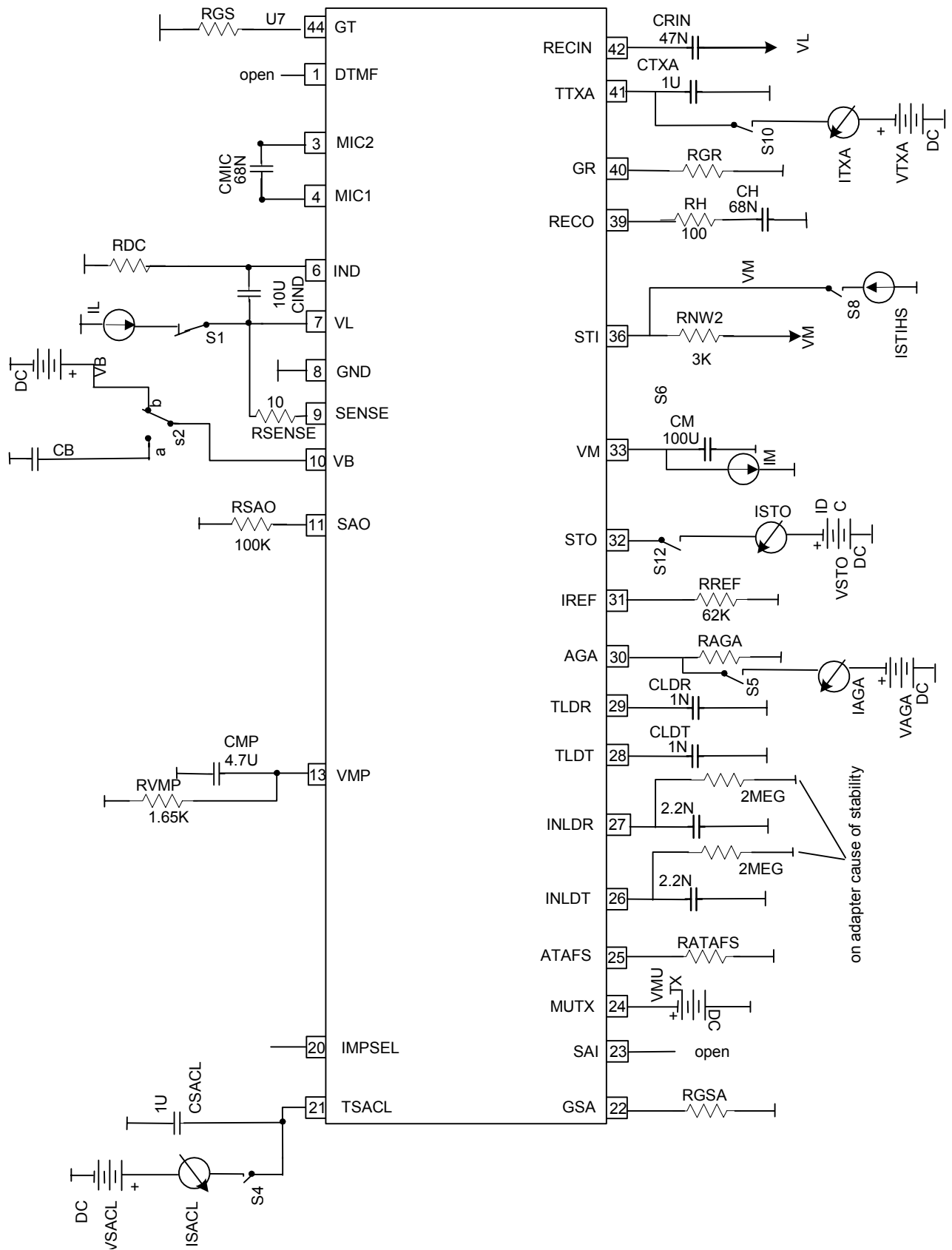


Figure 8-10. DC Ramps

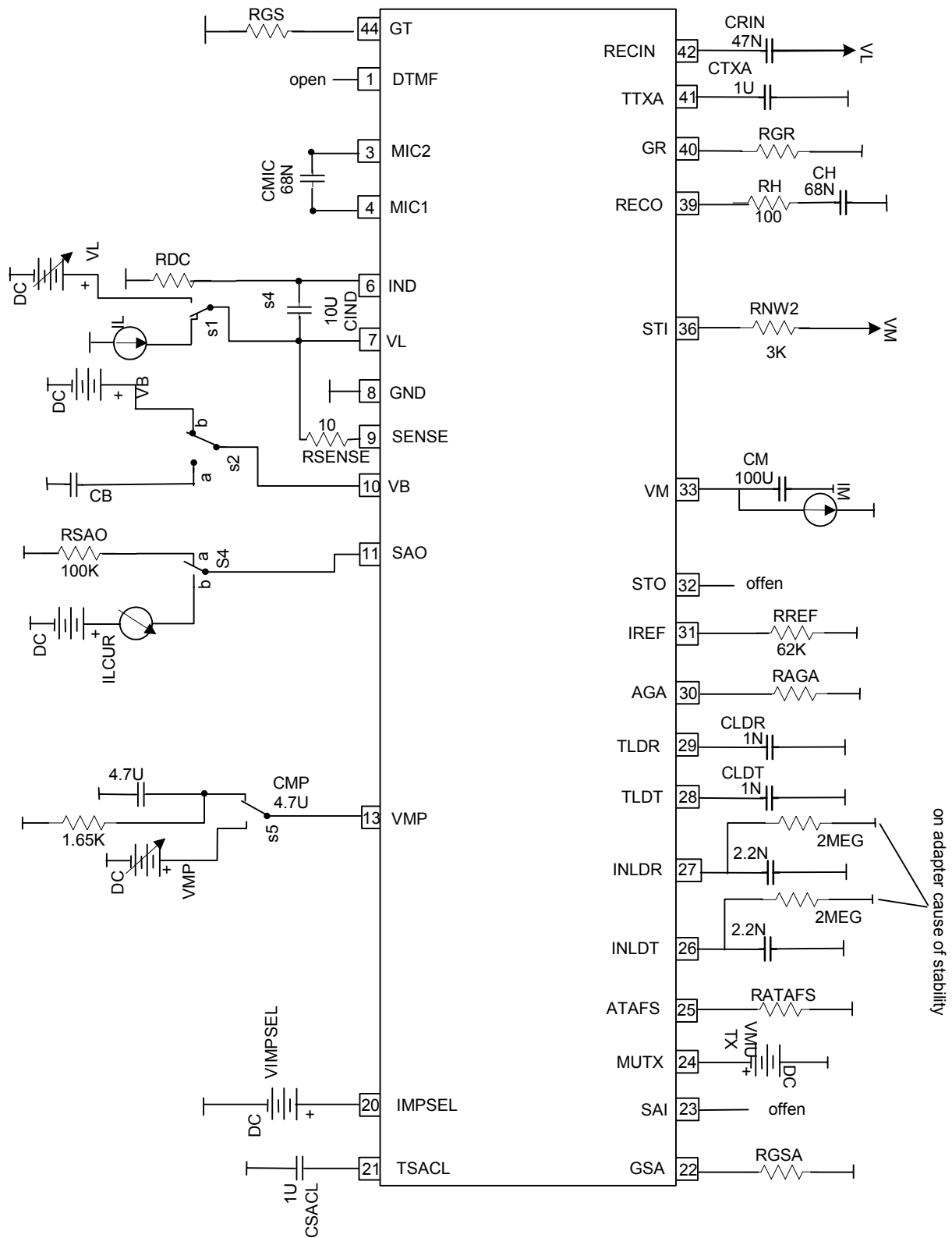


Figure 8-11. AC Tests

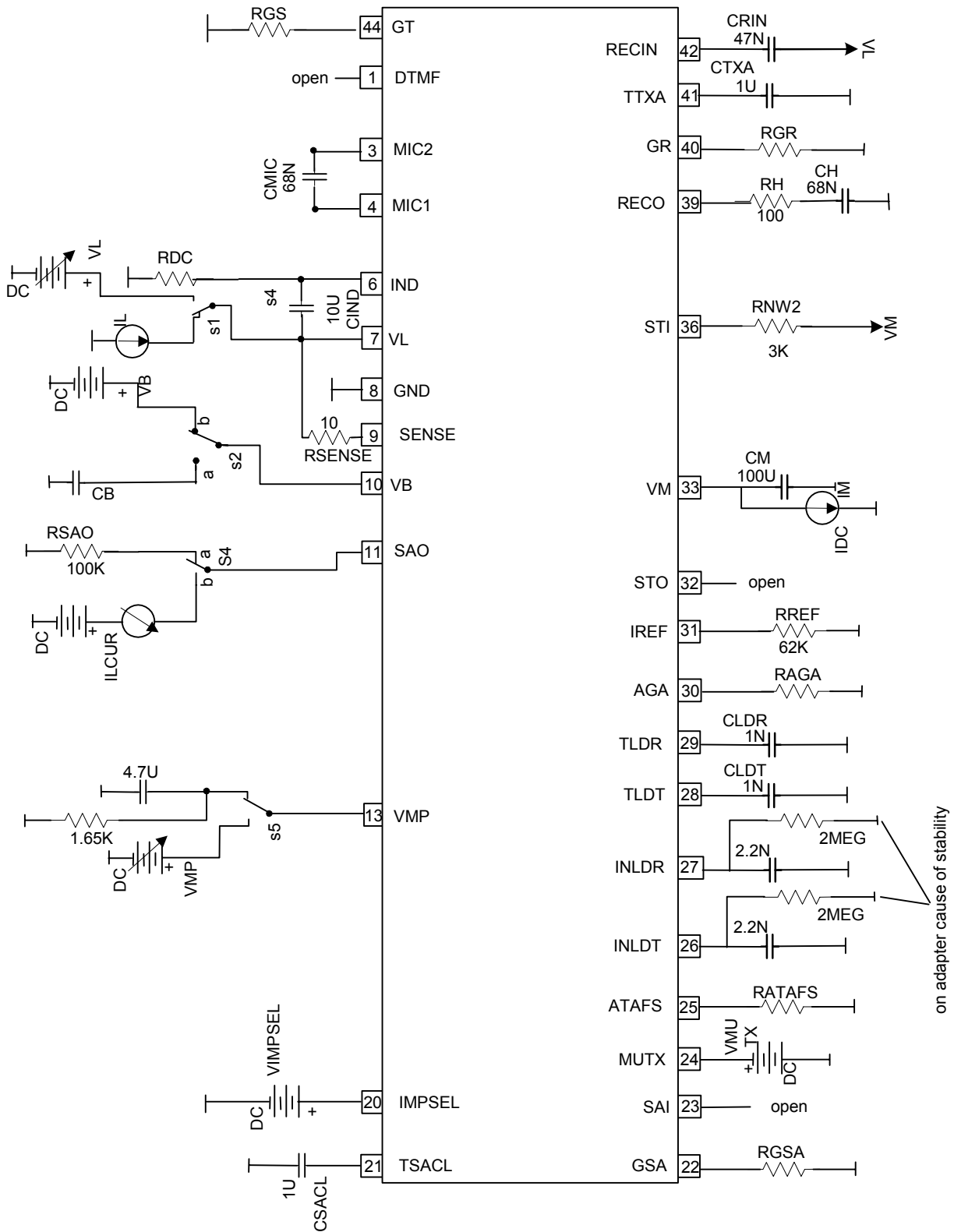
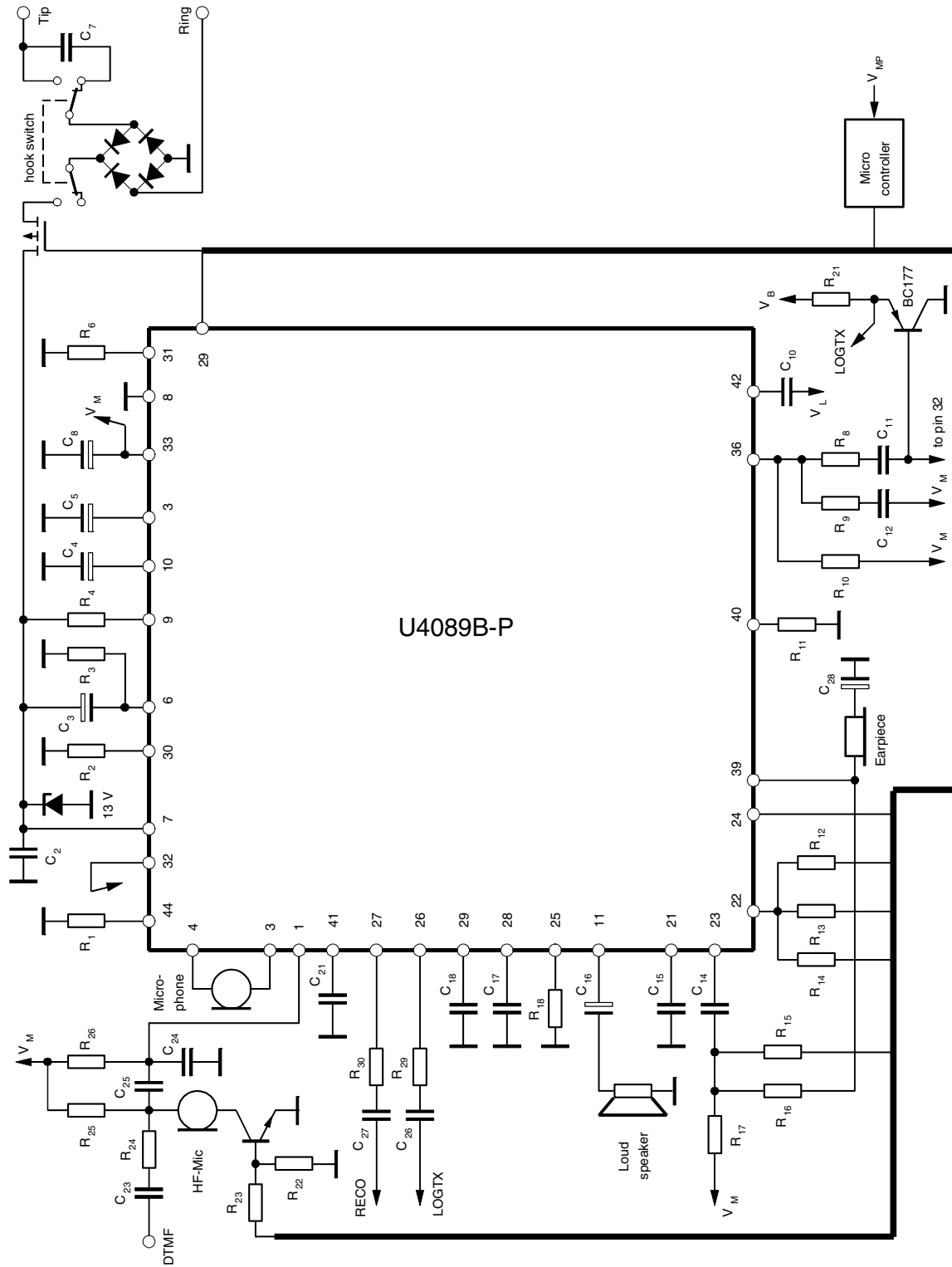


Table 8-2. Typical Values of External Components (see [Figure 8-12 on page 24](#))

Name	Value	Name	Value	Name	Value	Name	Value
C ₂	4.7 nF	C ₁₆	47 μF	R ₃	>68 kΩ	R ₁₆	1 kΩ
C ₃	10 μF	C ₁₇	10 μF	R ₄	10 kΩ	R ₁₇	1.2 kΩ
C ₄	220 μF	C ₁₈	10 μF	R ₆	62 kΩ	R ₁₈	30 kΩ
C ₅	47 μF	C ₂₁	1 μF	R ₈	22 kΩ	R ₂₁	15 kΩ
C ₇	1 μF	C ₂₃	6.8 nF	R ₉	330 kΩ	R ₂₂	330 kΩ
C ₈	100 μF	C ₂₄	10 nF	R ₁₀	3 kΩ	R ₂₃	220 kΩ
C ₁₀	150 nF	C ₂₅	100 nF	R ₁₁	62 kΩ	R ₂₄	68 kΩ
C ₁₁	68 nF	C ₂₆	470 nF	R ₁₂	30 kΩ	R ₂₅	2 kΩ
C ₁₂	33 nF	C ₂₇	33 nF	R ₁₃	62 kΩ	R ₂₆	3.3 kΩ
C ₁₄	100 nF	C ₂₈	10 μF	R ₁₄	120 kΩ	R ₂₉	1 kΩ
C ₁₅	1 μF	R ₂	20 kΩ	R ₁₅	47 kΩ	R ₃₀	12 kΩ

Figure 8-12. Application for Hands-free Operation

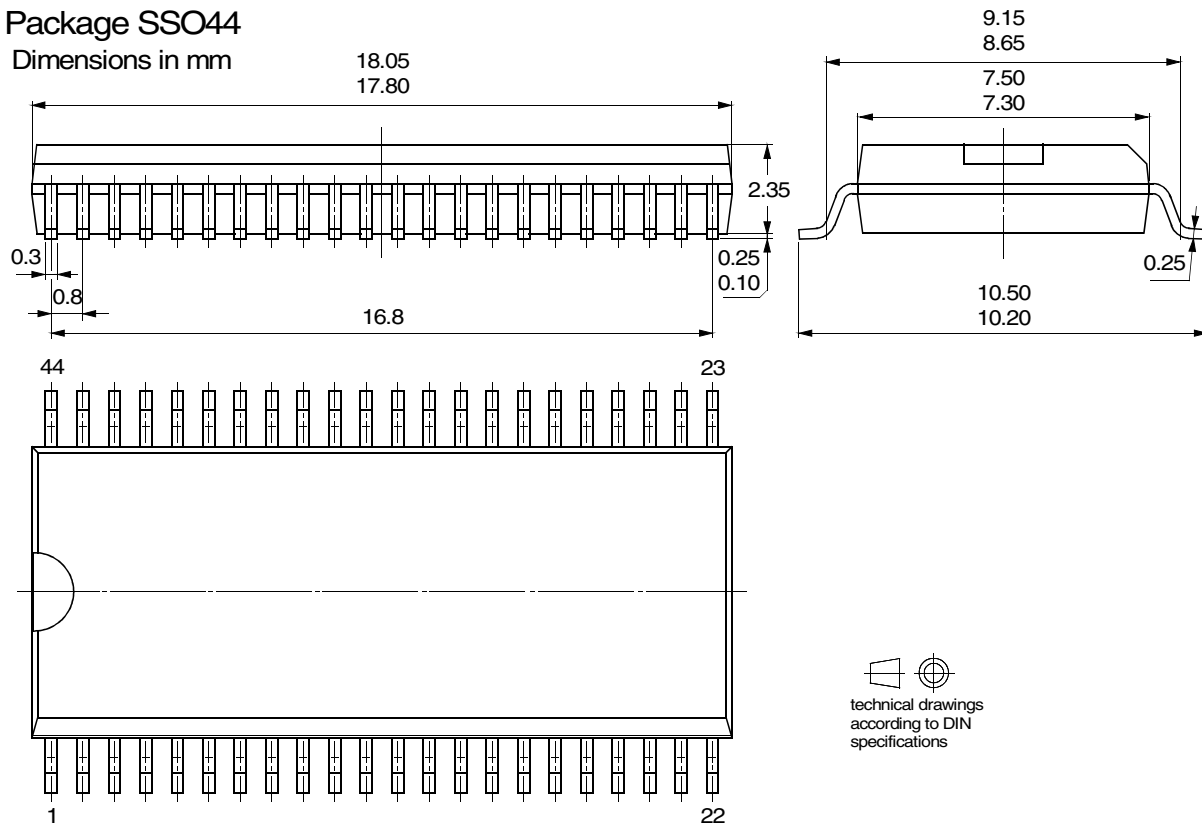



9. Ordering Information

Extended Type Number	Package	Remarks
U4089B-PFNY	SSO44	Tubes, Pb-free
U4089B-PFNG3Y	SSO44	Taped and reeled, Pb-free

10. Package Information

Package SSO44
Dimensions in mm




technical drawings
according to DIN
specifications



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